

General Description

SFGMOS[®]

$R_{DS(ON)}$, low gate charge, fast switching and excellent avalanche characteristics. The high V_{th} series is specially optimized for high systems with gate driving voltage greater than 10V.

Features

- Low $R_{DS(ON)}$ & FOM
- Extremely low switching loss
- Excellent stability and uniformity
- Fast switching and soft recovery



Applications

- Switched mode power supply
- Motor driver
- Battery protection
- DC-DC convertor
- Solar inverter
- UPS and energy inverter

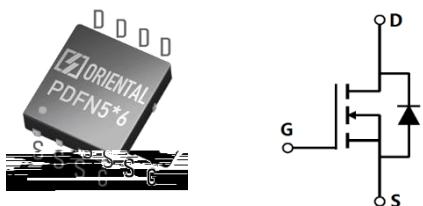
Key Performance Parameters

Parameter	Value	Unit
$V_{DS, min} @ T_{j(max)}$	80	V
$I_D, pulse$	300	A
$R_{DS(ON), max} @ V_{GS}=10V$	5.9	
Q_g	53.2	nC

Marking Information

Product Name	Package	Marking
SFG100N08GF	PDFN5*6	SFG100N08G

Package & Pin information



Absolute Maximum Ratings at $T_j=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Value	Unit
Drain source voltage	V_{DS}	80	V
Gate source voltage	V_{GS}	± 20	V
Continuous drain current ¹⁾ , $T_C=25\text{ }^\circ\text{C}$	I_D	100	A
Pulsed drain current ²⁾ , $T_C=25\text{ }^\circ\text{C}$	$I_{D,\text{pulse}}$	300	A
Continuous diode forward current ¹⁾ , $T_C=25\text{ }^\circ\text{C}$	I_S	100	A
Diode pulsed current ²⁾ , $T_C=25\text{ }^\circ\text{C}$	$I_{S,\text{pulse}}$	300	A
Power dissipation ³⁾ , $T_C=25\text{ }^\circ\text{C}$	P_D	148	W
Single pulsed avalanche energy ⁵⁾	E_{AS}	135	mJ

Operation and storage temperature

 T_{stg} T_j

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Dynamic Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Input capacitance	C_{iss}		4242		pF	$V_{GS}=0\text{ V}$, $V_{DS}=25\text{ V}$, 100 kHz
Output capacitance	C_{oss}		1779		pF	
Reverse transfer capacitance	C_{rss}		84.1		pF	
Turn-on delay time	$t_{d(on)}$		28		ns	$V_{GS}=10\text{ V}$, $V_{DS}=40\text{ V}$, R_G $I_D=50\text{ A}$
Rise time	t_r		6.5		ns	
Turn-off delay time	$t_{d(off)}$		48.5		ns	
Fall time	t_f					

Electrical Characteristics Diagrams

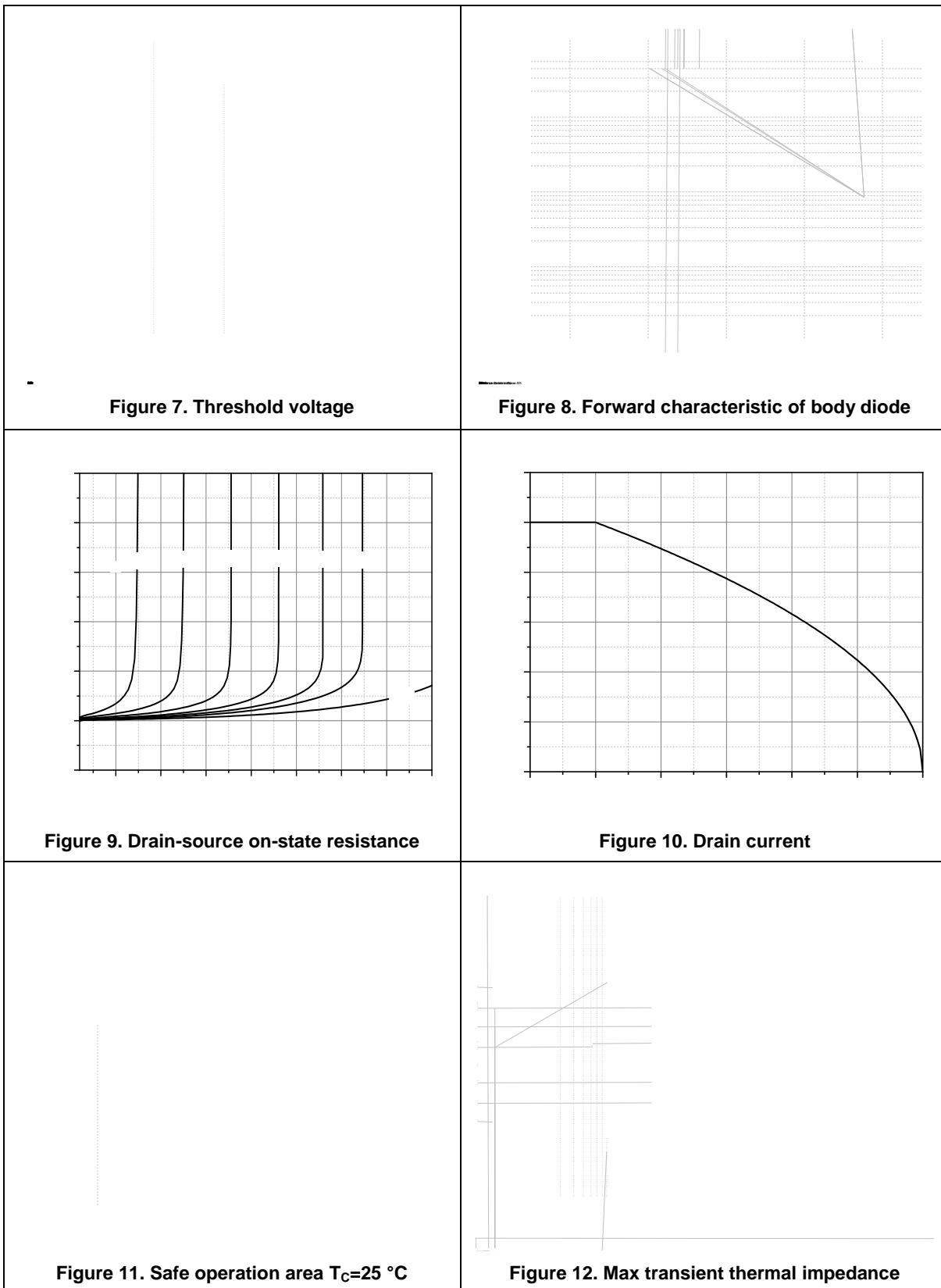


Figure 7. Threshold voltage

Figure 8. Forward characteristic of body diode

Figure 9. Drain-source on-state resistance

Figure 10. Drain current

Figure 11. Safe operation area $T_c=25\text{ }^\circ\text{C}$

Figure 12. Max transient thermal impedance

Test circuits and waveforms

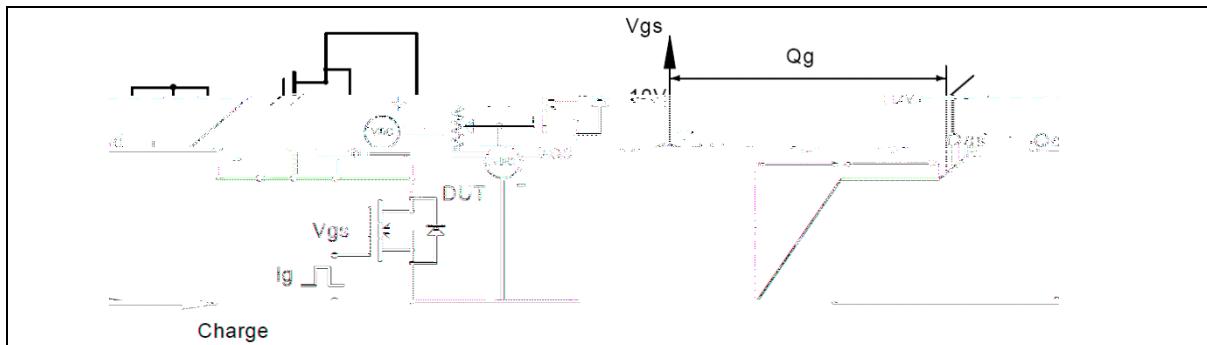


Figure 1. Gate charge test circuit & waveform

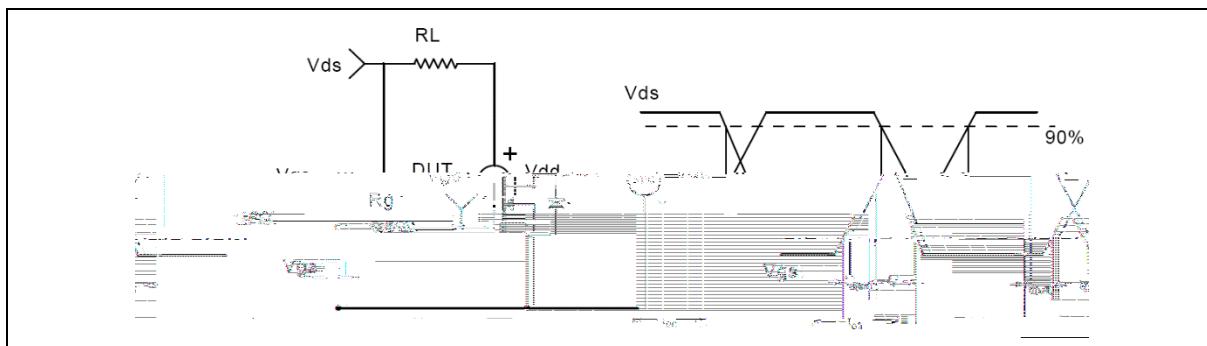


Figure 2. Switching time test circuit & waveform

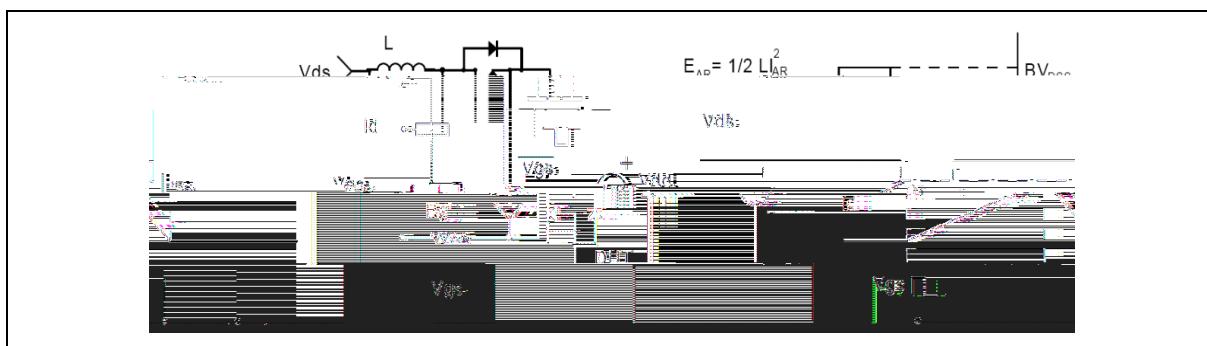


Figure 3. Unclamped inductive switching (UIS) test circuit & waveform

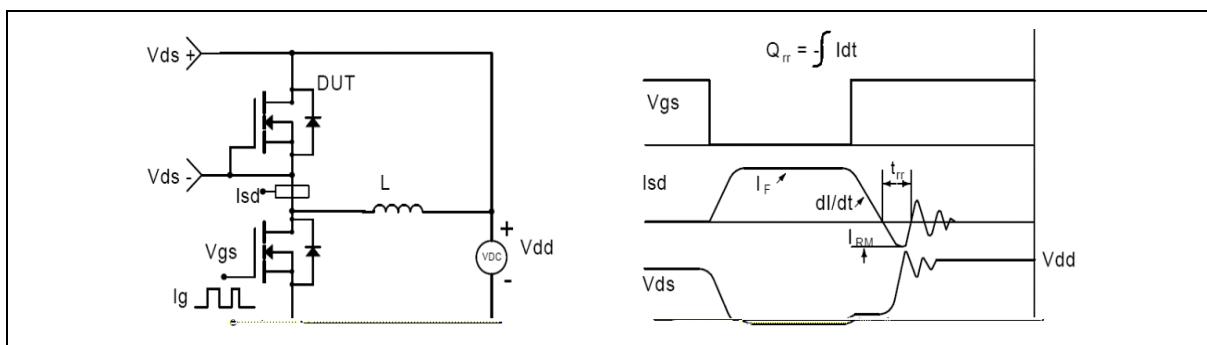


Figure 4. Diode reverse recovery test circuit & waveform



Package Information

Symbol	mm		
	Min	Nom	Max
A	1.00	1.10	1.20
b	0.30	0.40	0.50
c	0.154	0.254	0.354
D1	5.00	5.20	5.40
D2	3.80	4.10	4.25
e	1.17	1.27	1.37
E1	5.95	6.15	6.35
E2	5.66	5.86	6.06
E4	3.52	3.72	3.92
H	0.40	0.50	0.60
L	0.30	0.60	0.70
L1	0.12 REF		
K	1.15	1.30	1.45

Version 1: PDFN5*6-C package outline dimension

